

INFORMATION DISCLOSURE CITATION

(Use several sheets if necessary)

Docket Number (Optional)

EN999008 US2

Application Number

Applicant(s)

Brodsky et al

Filing Date

Group Art Unit

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	AA	5,731,222	3/1998	Malloy et al			
	AB	5,760,465	6/1998	Alcoe et al			
	AC	5,770,884	6/1998	Pogge et al			
	AD	5,708,300	1/1998	Woodsley et al			
	AE	6,118,178	9/2000	Takeuchi			
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						

FOREIGN PATENT DOCUMENTS

	REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
							YES	NO
	AL	5-36825	1993	Japan				
	AM	4-37355	1992	Japan				
	AN	4-253359	1992	Japan				
	AO	3-241856	1991	Japan				
	AP	2-155231	1990	Japan				

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

AR	"High Performance Carrier Technology: Materials And Fabrication", by Light et al, 1993 International Electronics Packaging Conference, San Diego, California; Volume One.
AS	"High Performance Carrier Technology", by Heck et al, 1993 International Electronics Packaging Conference, San Diego, California, Volume One.

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DATE CONSIDERED

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	REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
							YES	NO
	AL	0840332 A2	5/1998	EPO				
	AM	2174539 A	11/1986	Great Britain				
	AN	EP 97118837	2/2000	European Search				
	AO							
	AP							

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

	AR	"Process Considerations in the Fabrication of Teflon Printed Circuit Boards", by Light et al, 1994 Proceedings, 44 Electronic Components & Technology Conference, 5/94.

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